

PRESS RELEASE

Lasertec Corporation

2-10-1 Shin-yokohama, Kohoku-ku, Yokohama
(Code 6920 / Tokyo Stock Exchange, 1st Section)

Yokohama, Japan, November 5, 2015 – Lasertec Corporation today announced that Cree Inc. (NASDAQ: CREE) has chosen to install an additional SICA™ SiC wafer inspection and review system. Cree is an industry leader in the area of SiC substrates, SiC power devices and GaN LED.

SICA is designed to help fab engineers accelerate yield improvements by providing high sensitivity defect inspection and highly accurate on-the-fly defect classification along with fully automated defect review feature. SICA enables SiC substrate and device manufacturers to take corrective action sooner and improve their yields and productivity more quickly. The tool's user interface provides an intuitive graphical method for creating inspection recipes, further increasing its ease of use for automated reporting. Optional SICA Viewer provides ultimate convenience for engineers who need to work outside of the clean room.

"High sensitivity, on-the-fly ADC and automated review function enable customers to analyze defects quickly and this translates directly to a company's profitability by improving the device yield," said Hirokazu Seki, SICA project leader of Lasertec. "Since we introduced SICA6X in 2011, complete systems have been installed at major SiC power device companies and consortiums in Asia and now our market is quickly expanding to global locations. This recent success with Cree highlights the benefits that SICA offers our customers."

About Lasertec:

As a leader in metrology and inspection tooling, Lasertec Corporation has been serving the needs of semiconductor, compound semiconductor, renewable energy, FPD and other high technology industries for many years. Since its beginning in 1960, Lasertec has been evolving and growing to keep pace with the world's rapidly expanding and changing high technology manufacturing requirements. In addition to the innovative technologies, Lasertec's global support infrastructure assures customers full satisfaction through high tool availability that maximizes the capital investment and device yield. For more information, go to: www.lasertec.co.jp/en.

Contact:

In Asia:

Genichiro Kamiyama

Leader, Solution Sales Department 1

Phone: +81-45-478-7337

<http://www.lasertec.co.jp>

In US/Europe:

Yuji Asakawa

Director, Sales & Business Development Department

Phone: +1-408-437-4065